RESPONSE TO NON-FINAL OFFICE ACTION
Sexial No. 10/636,181

METHOD FOR ERASING AN NROM CELL

AMENDMENTS TO THE CLAIMS

(currently amended) A method for erasing a nitride read only memory (NROM) block comprising a plurality of memory cells each having a gate input and two source/drain regions, the method comprising:

erasing the memory block; and

performing a recovery operation on the plurality of memory cells such that a threshold voltage indicating a programmed state, for over-erased cells, is increased <u>by</u> coupling the gate input to a ramped voltage, a first source/drain region to a first constant voltage, and the remaining source/drain region to a second constant voltage.

- 2. (canceled)
- 3. (Original) The method of claim 1 wherein the ramped voltage starts in a range of -3 to 0V and ends in a range of 1 to 3V.
- 4. (Original) The method of claim 3 wherein the ramp voltage has a time period in a range of 10 microseconds to 1 second from start to end.
- 5. (Original) The method of claim 2 wherein the first constant voltage is in a range of 3 to 7V.
- 6. (Original) The method of claim 2 wherein the second constant voltage is in a range of 0 to 3V.
- 7. (Original) The method of claim 1 wherein the nitride read only memory cell is embedded in a CMOS device.
- 8. (Withdrawn) A method for erasing a nitride read only memory (NROM) block comprising a plurality of short-channel memory cells each having a gate input and two source/drain regions, the method comprising: erasing the memory block; and
 - performing a recovery operation on the plurality of memory cells such that a threshold voltage indicating a programmed state, for over-erased cells, is increased, the

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recovery operation includes biasing each of the plurality of memory cells with a ramped voltage on the gate input, a constant voltage on a first source/drain region and the remaining source/drain region left floating.

- 9. (Withdrawn) The method of claim 8 and further comprising an oxide-nitride-oxide region, between the first and second source/drain regions, that can hold a single data bit.
- 10. (Withdrawn) The method of claim 8 wherein the constant voltage is in a range of 3 to 7V and the ramped voltage starts in a range of -3 to 0V and ends in a range of 1 to 3V over a time period in a range of 10 microseconds to 1 second.
- 11. (Withdrawn) The method of claim 8 wherein erasing the memory block includes biasing each of the plurality of cells with a first constant voltage on the gate input, a second constant voltage on a first source/drain region, and a third constant voltage on the remaining source/drain region.
- 12. (Withdrawn) The method of claim 11 wherein the first constant voltage is in a range of -12 to 0, the second constant voltage is in a range of 3 to 8V, and the third constant voltage is in a range of 3 to 8V.
- 13. (Withdrawn) The method of claim 11 wherein the first source/drain region acts as a drain connection and the remaining source/drain region acts as a source region.
- 14. (Withdrawn) The method of claim 13 wherein the source region is allowed to float.
- 15. 21. (Canceled)